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1-3	31-92 3-30-98				Trademark Office					
Tot	the Honorable Commissioner of Patents and 1006787		ocuments or copy	thereof.	O L					
1.	Name of conveying party(ies): 1. Jean-Christophe Martin	2. Name and a	ddress of receiving	party(ies):	S. 546					
		Name:	Sun Micros	systems, Inc.	200					
Add	ditional name(s) of conveying party(ies) attached? Tyes X No	Internal Add	ress: 901 San An		200					
3.	Nature of conveyance:				S					
	X Assignment	Street Address: 901 San Antonio Road								
Fye	cution Date: 1. 03/17/98	City: Palo A	Alto State: CA s) & address(es) att							
4.	Application number(s) or patent number(s):	Additional fiame(o) a address(es) att	ached? LYes XN	0					
,	If this document is being filed together with a new application, the execution	on data of the appli	antion in: 1 02	117/00						
		1								
A. Patent Application No.(s) Additional numbers attached? B. Patent No.(s)										
	Additional numbers attached	? Yes [⊈ No							
5.	Name and address of party to whom correspondence concerning document should be mailed:	6. Total numbe	r of applications and	d patents involved:	1					
	Name: BLAKELY, SOKOLOFF, TAYLOR & ZAFMAN									
	Internal Address: 12400 Wilshire Boulevard 7th Floor	7. Total fee (37	CFR 3.41)\$	40.00						
	Los Angeles, CA 90025-1026	☐ Enclose	ed.							
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9.	Statement and signature To the best of my knowledge and belief, the foregoing information is true and Patrick J. S. Inouve	nd correct and any a		ue copy of the original d	ocument.					
	Name of Person Signing Signature			ate						
	Tota	al number of pages	comprising cover s	heet: 2						
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(06	51-0011), Washington, D.C. 20503.									

REF: P/2837/EJB

<u>ACKNOWLEDGEN</u>	<u>IENT</u> by an Em	ployee of the Righ	t to apply for a Pa	atent and AN	ASSIGNMENT	made on
17th	day of	March	1998 <u>BET</u>			

JEAN-CHRISTOPHE MARTIN, of FRENCH nationality, of LE PETIT ROCHEFORT, ROUTE DE BEAUREGARD, 38760 VARCES, FRANCE (hereinafter referred to as "Inventor") of the first part;

SUN MICROSYSTEMS FRANCE, S.A., a FRENCH company, having a place of business at 13 AVENUE MORANE SAULNIER, 78140 VELIZY-VILLACOURBLAY, FRANCE (hereinafter referred to as "Employer Company") of the second part; AND

SUN MICROSYSTEMS, INC., a corporation of Delaware, United States of America, having a place of business at M/S PAL1-521, 2550 GARCIA AVENUE, MOUNTAIN VIEW, CALIFORNIA 94043-1100, UNITED STATES OF AMERICA (hereinafter referred to as "Parent Company") of the third part.

WHEREAS :-

- (A) Each Inventor claims jointly with the other Inventor(s) to have made the Invention described in the Schedule (hereinafter referred to as "the Invention");
- (B) The Invention has been made by the Inventors during the period of their employment with the Employer Company and in the course of their normal duties with the Employer Company and by virtue of the terms of their employment with the Employer Company, the Invention is to be taken as between the Employer Company and the Inventors to belong to the Employer Company;
- (C) The Employer Company agrees to assign the Invention and the right to apply for a patent or patents relating to the said Invention to the Parent Company together with all rights title and beneficial interest in and arising therefrom.

NOW THIS AGREEMENT WITNESSES as follows:-

- 1. Each Inventor HEREBY ACKNOWLEDGES that the Invention and all rights therein including the right to apply for a patent or patents relating to the Invention belongs to the Employer Company, and pursuant thereto HEREBY ASSIGNS TO AND CONFIRMS the vesting in the Employer Company of:
- (a) the whole of the property in the Invention throughout the world and any protection obtained at any time therefor and all rights title and interest which the Inventor may have or have been entitled to therein including all rights to bring proceedings for infringement thereof together with the full and exclusive benefit thereof; and (b) the right to apply for and obtain or to enable others to apply for and obtain a patent or patents or any other form of protection in respect of the Invention both in the United States of America and throughout the world.
- 2. In pursuance of the agreement referred to in Recital (C) and IN CONSIDERATION of the sum of FIVE US DOLLARS, receipt of which is hereby confirmed, the Employer Company hereby assigns to the Parent Company all its rights in the Invention including the right to apply for a patent or patents and to exploit the Invention or any patent or other protection obtained in respect thereof TO HOLD the same unto the Parent Company absolutely.
- 3. Each Inventor hereby undertakes to the Parent Company that he/she will at the expense of the Parent Company execute all documents and do all such acts and things as the Parent Company may in its absolute discretion consider necessary or desirable to enable Letters Patent or any form of protection to be issued in respect of the Invention in any part or parts of the world and to vest the same in the name of the Parent Company or its nominee free from all encumbrances and to enable or to assist the Parent Company or its nominee to defend oppositions to grant thereof, to maintain the same when granted and to present and prosecute for the infringement thereof.

PATENT REEL: 9056 FRAME: 0059

- 4. Each Inventor hereby warrants to the Employer Company and to the Parent Company:
- (a) that he/she has not assigned or agreed to assign to any person firm or company or otherwise encumbered the Invention or any other part of the rights therein and thereto;
- (b) that he/she has not disclosed and will not disclose the Invention to any person firm or company other than the Employer Company or the Parent Company except as directed by the Employer Company or the Parent Company;
- (c) that he/she will give to the Employer Company or the Parent Company all information in his/her possession or in his/her power relating to the Invention and the method of employing or using the same as the Employer Company or the Parent Company shall require;
- (d) that he/she knows of no reason why a valid patent or valid patents relating to the Invention should not be granted either to himself/herself or to his/her successors in title.

IN WITNESS thereof the parties have duly executed this document the day and year first above written

SCHEDULE

The invention is as described in the attached draft specification entitled:- "QUALITY OF SERVICE ALLOCATION ON A NETWORK"

SIGNED by the Inventor:

Witness

JEAN-CHRISTOPHE MARTIN

SIGNED for and on behalf of SUN MICROSYSTEMS FRANCE S.A.:

Witness

Witness-

MICHAEL LEHMAN

DIRECTOR

SUN MICROSYSTEMS FRANCE S.A

SIGNED for and on behalf

of SUN MICROSYSTEMS, INC

KENNETH OLSEN

VICE PRESIDENT INTELLECTUAL PROPERTY

SUN MICROSYSTEMS, INC